

Silicon Carbide Power MOSFET C3M[™] MOSFET Technology N-Channel Enhancement Mode

Features

- 3rd Generation SiC MOSFET technology
- High blocking voltage with low on-resistance
- High speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Qrr)
- Halogen free, RoHS compliant

Benefits

- Higher system efficiency
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency
- Easy to parallel and simple to drive
- Enable new hard switching PFC topologies (Totem-Pole)

Applications

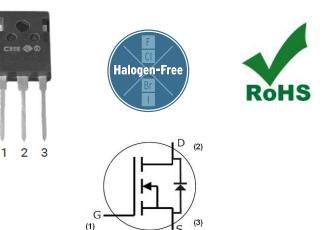
- EV charging
- Solar PV Inverters
- UPS
- SMPS
- DC/DC converters

Maximum Ratings (T_c=25°C, unless otherwise specified)

Symbol	Parameter	Value	Unit	Note
V _{DSmax}	Drain - Source Voltage	650	V	
V_{GSmax}	Gate - Source voltage	-8/+19	V	Note 1
	Continuous Drain Current, $V_{GS} = 15 \text{ V}$, $T_C = 25^{\circ}\text{C}$	120		Fig. 19 Note 2
ID	Continuous Drain Current, $V_{GS} = 15 \text{ V}$, $T_C = 100^{\circ}\text{C}$	96		
I _{D(pulse)}	Pulsed Drain Current, Pulse width t_p limited by T_{jmax}	418	A	
P _D	Power Dissipation, $T_c = 25^{\circ}C$, $T_j = 175^{\circ}C$	416	W	Fig. 20
T _J , T _{stg}	Operating Junction and Storage Temperature		°C	
TL	Solder Temperature, 1.6mm (0.063") from case for 10s	260	°C	
M _d	Mounting Torque, (M3 or 6-32 screw)	1 8.8	Nm Ibf-in	

Note (1): Recommended turn off / turn on gate voltage V $_{\rm GS}\,$ - 4V...0V / +15V Note (2): Package limited to 120 A

Package



Part Number	Package	Marking	
C3M0015065D	TO-247-3	C3M0015065D	



Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note	
$V_{\text{(BR)DSS}}$	Drain-Source Breakdown Voltage	650			V	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$		
M		1.8	2.3	3.6	V	$V_{DS} = V_{GS}, I_D = 15.5 \text{ mA}$		
$V_{GS(th)}$	Gate Threshold Voltage		1.9		V	$V_{DS} = V_{GS}$, $I_D = 15.5 \text{ mA}$, $T_J = 175^{\circ}\text{C}$		
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μΑ	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$		
I _{GSS}	Gate-Source Leakage Current		10	250	nA	$V_{GS} = 15 \text{ V}, V_{DS} = 0 \text{ V}$		
$R_{\text{DS(on)}}$	Drain-Source On-State Resistance	10.5	15	21	mΩ	$V_{GS} = 15 \text{ V}, I_D = 55.8 \text{ A}$	Fig. 4,	
DS(on)			20		11132	$V_{GS} = 15 \text{ V}, I_D = 55.8 \text{ A}, T_J = 175^{\circ}\text{C}$	5,6	
g _{fs}	Transconductance		42		s	V_{DS} = 20 V, I_{DS} = 55.8 A	Fig. 7	
913			40			V_{DS} = 20 V, I_{DS} = 55.8 A, T_J = 175°C		
C _{iss}	Input Capacitance		5011					
C _{oss}	Output Capacitance		289				Fig. 17 18	
C _{rss}	Reverse Transfer Capacitance		31	1	рF	$V_{GS} = 0 V, V_{DS} = 400 V$		
C _{o(er)}	Effective Output Capacitance (Energy Related)		357			f = 100 Khz V _{AC} = 25 mV	Note	
C _{o(tr)}	Effective Output Capacitance (Time Related)		516			VAC= 23 111V	Note	
E _{oss}	Coss Stored Energy		29		μ		Fig. 1	
Eon	Turn-On Switching Energy (Body Diode)		1500			$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_D = 55.8 \text{ A},$ $R_{G(ext)} = 5 \Omega, L = 57.6 \mu\text{H}, T_J = 175^{\circ}\text{C}$	Fig. 25	
E _{OFF}	Turn Off Switching Energy (Body Diode)		700		μJ	FWD = Internal Body Diode of MOSFET		
E _{ON}	Turn-On Switching Energy (External Diode)		1200			$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 55.8 \text{ A},$	1	
E _{OFF}	Turn Off Switching Energy (External Diode)		1000		μJ	$R_{G(ext)} = 5 \Omega$, L= 57.6 µH, T _J = 175°C FWD = External SiC DIODE	Fig. 2	
$t_{d(\text{on})}$	Turn-On Delay Time		22					
tr	Rise Time		125			$V_{DD} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 55.8 \text{ A}, R_{G(ext)} = 5 \Omega, L = 57.6 \mu\text{H}$ Timing relative to V _{DS} Inductive load		
$t_{d(off)}$	Turn-Off Delay Time		58		ns		Fig. 2	
t _f	Fall Time		25					
$R_{G(int)}$	Internal Gate Resistance		1.5		Ω	$f = 1 MHz$, $V_{AC} = 25 mV$		
Q_{gs}	Gate to Source Charge		54			$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$	Fig. 12	
Q_{gd}	Gate to Drain Charge		62	_	nC	I _D = 55.8 A		
Qg	Total Gate Charge		188			Per IEC60747-8-4 pg 21		

Note (3): C_{o(er)}, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 400V C_{o(tr)}, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 400V



Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V _{SD}				v	$V_{GS} = -4 \text{ V}, \text{ I}_{SD} = 27.9 \text{ A}, \text{ T}_{J} = 25 \text{ °C}$	Fig. 8,
V _{SD}	Diode Forward Voltage	4.2		v	$V_{_{GS}} = -4 \text{ V}, \text{ I}_{_{SD}} = 27.9 \text{ A}, \text{ T}_{_{J}} = 175 ^{\circ}\text{C}$	9, 10
ls	Continuous Diode Forward Current		79	A	$V_{GS} = -4 V, T_C = 25^{\circ}C$	
I _{S, pulse}	Diode pulse Current		418	A	$V_{_{GS}} = -4 V$, pulse width t_p limited by T_{jmax}	
t _{rr}	Reverse Recovery time	85		ns		
Q _{rr}	Reverse Recovery Charge	667		nC	$V_{GS} = -4 V, I_{SD} = 55.8 A, V_{R} = 400 V$ dif/dt = 1500 A/µs, T _j = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	17		A		
t _{rr}	Reverse Recovery time	74		ns		
Q _{rr}	Reverse Recovery Charge	562		nC	$V_{cs} = -4 V, I_{sD} = 55.8 A, V_{R} = 400 V$ dif/dt = 1000 A/µs, T _j = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	14		A		

Thermal Characteristics

Symbol	Parameter	Тур.	Unit	Test Conditions	Note
R _{ejc}	Thermal Resistance from Junction to Case	0.35	0C ///		Fig. 21
R _{0JA}	Thermal Resistance From Junction to Ambient	40	°C/W		Fig. 21



Typical Performance

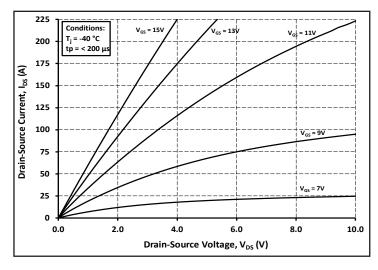


Figure 1. Output Characteristics T_J = -40 °C

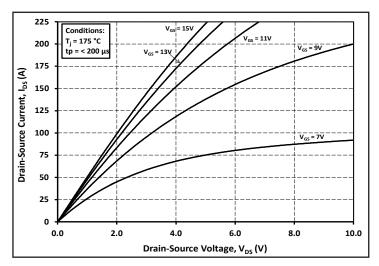


Figure 3. Output Characteristics T_J = 175 °C

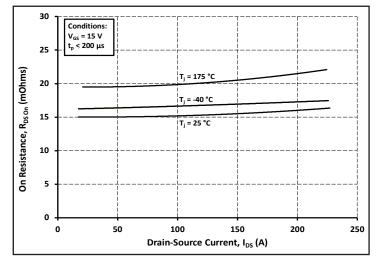


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

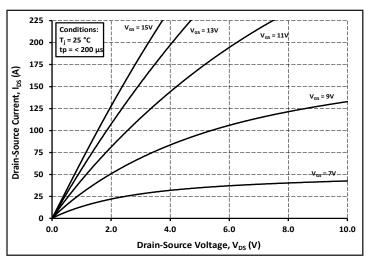
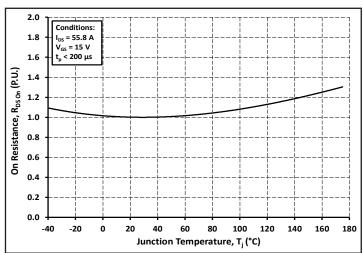


Figure 2. Output Characteristics T_J = 25 °C





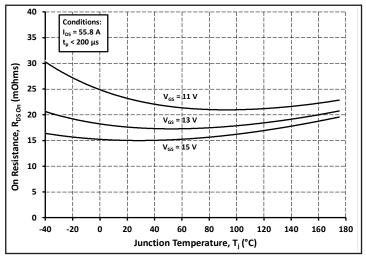
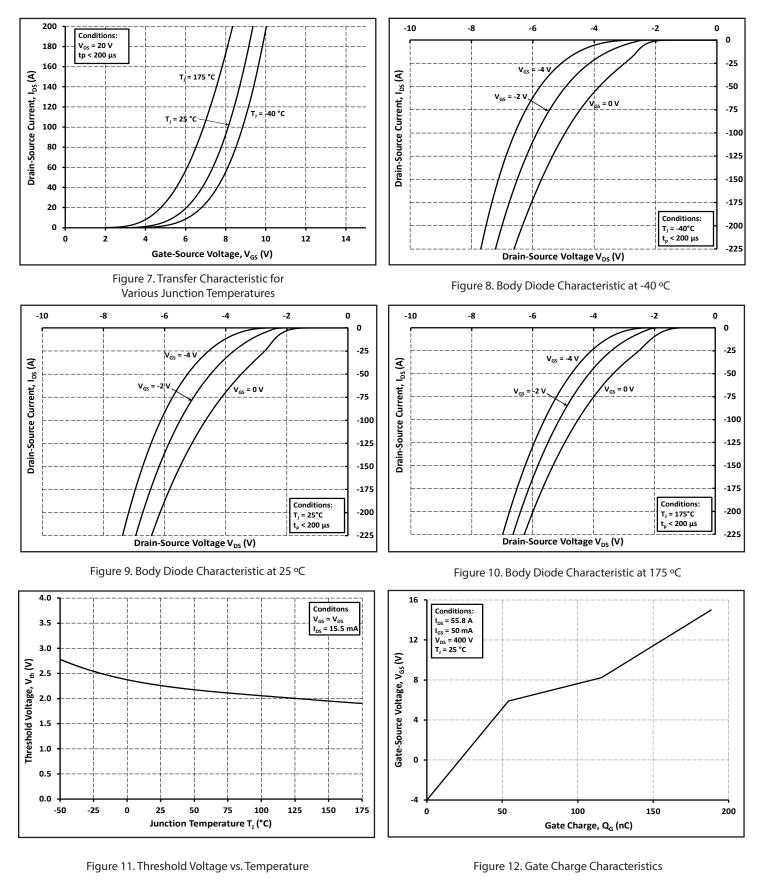


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage



Typical Performance



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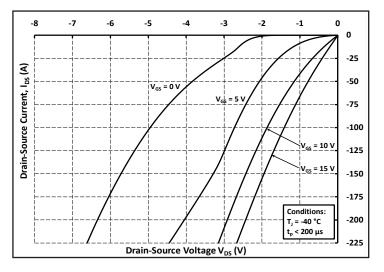


Figure 13. 3rd Quadrant Characteristic at -40 °C

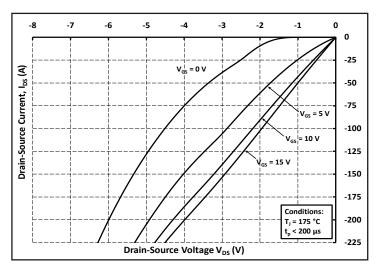
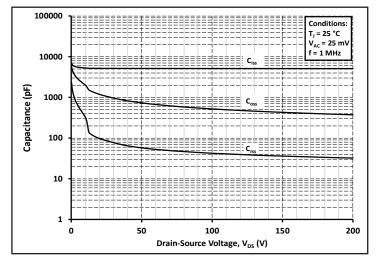
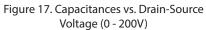


Figure 15. 3rd Quadrant Characteristic at 175 °C





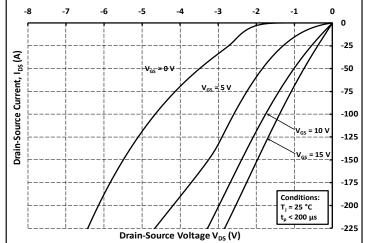


Figure 14. 3rd Quadrant Characteristic at 25 °C

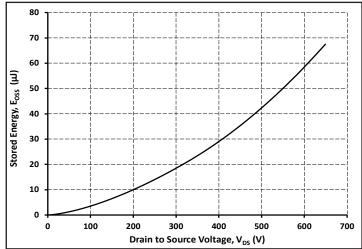


Figure 16. Output Capacitor Stored Energy

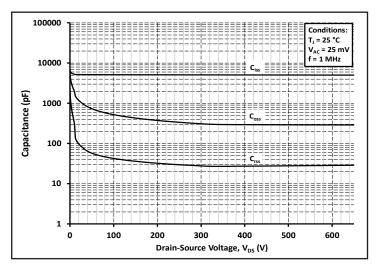
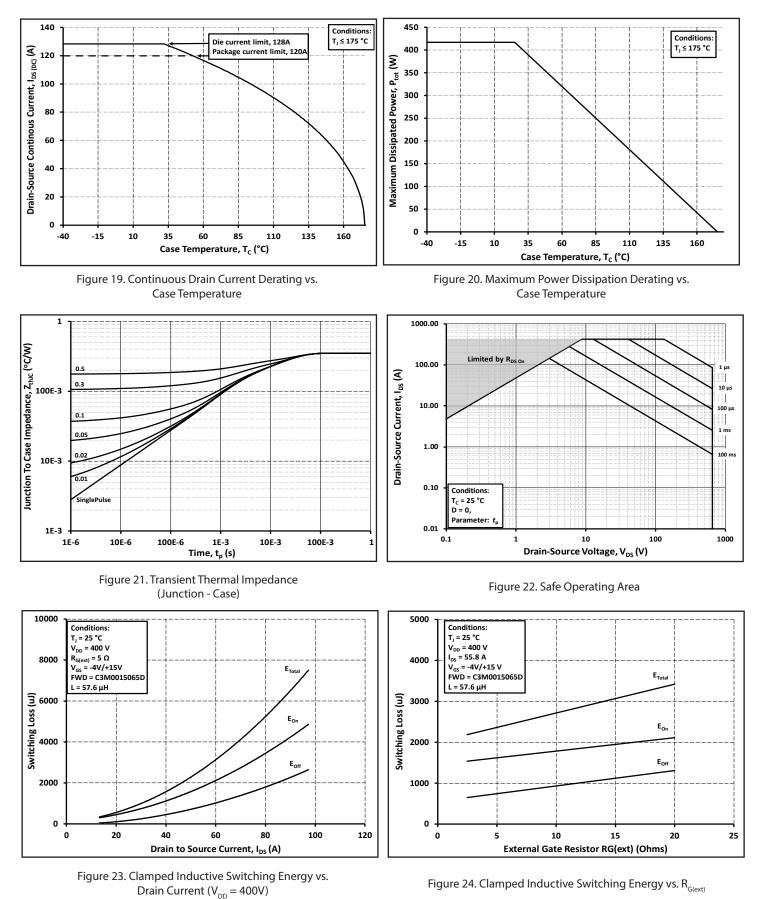


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 650V)



Typical Performance



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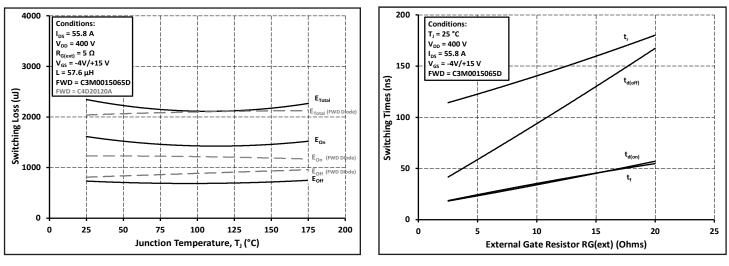


Figure 25. Clamped Inductive Switching Energy vs. Temperature





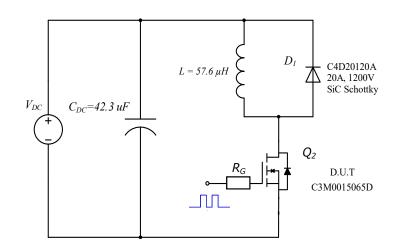


Figure 27. Clamped Inductive Switching Waveform Test Circuit

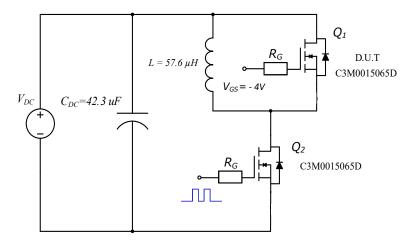
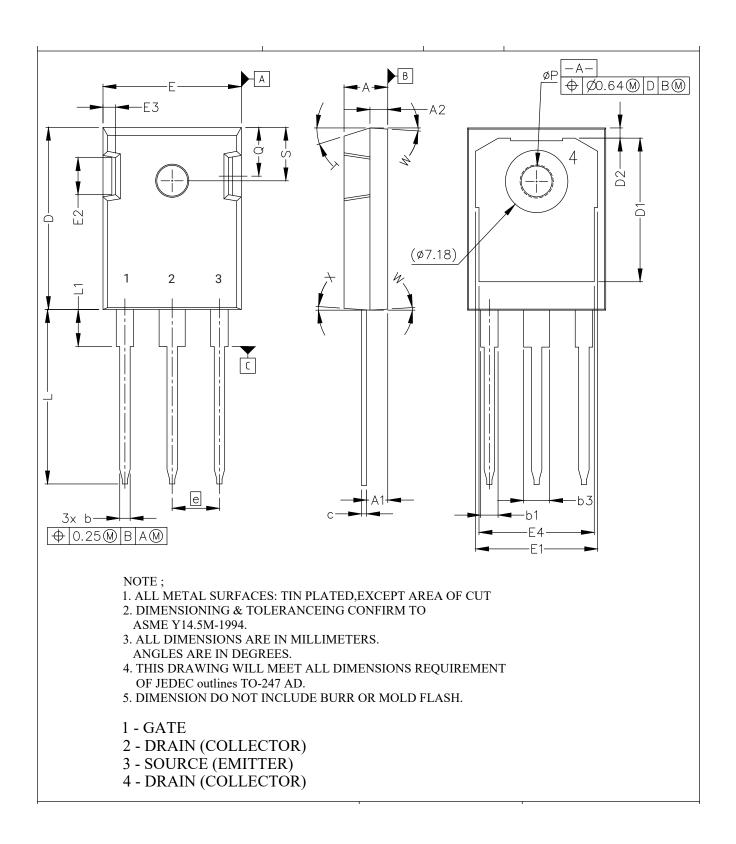


Figure 28. Body Diode Recovery Test Circuit



Package Dimensions

Package TO-247-3



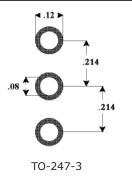
Package Dimensions

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CVAL	MILLIM	ETERS	INC	HES		
SYM	MIN	MAX	MIN	MAX		
Α	4.83	5.21	.190	.205		
A1	2.29	2.54	.090	.100		
A2	1.91	2.16	.075	.085		
b	1.07	1.33	.042	.052		
b1	1.91	2.41	.075	.095		
b3	2.87	3.38	.113	.133		
с	0.55	0.68	.022	.027		
D	20.80	21.10	.819	.831		
D1	16.25	17.65	.640	.695		
D2	0.95	1.25	.037	.049		
E	15.75	16.13	.620	.635		
E1	13.10	14.15	.516	.557		
E2	3.68	5.10	.145	.201		
E3	1.00	1.90	.039	.075		
E4	12.38	13.43	.487	.529		
e	5.44 BSC	2	.214 E	BSC		
N	3		3			
L	19.81	20.32	.780	.800		
L1	4.10	4.40	.161	.173		
ØP	3.51	3.65	.138	.144		
Q	5.49	6.00	.216	.236		
S	6.04	6.30	.238	.248		
Т	17.5° REF.					
W	3.5° REF.					
Х	4° REF.					

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Recommended Solder Pad Layout





Notes

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